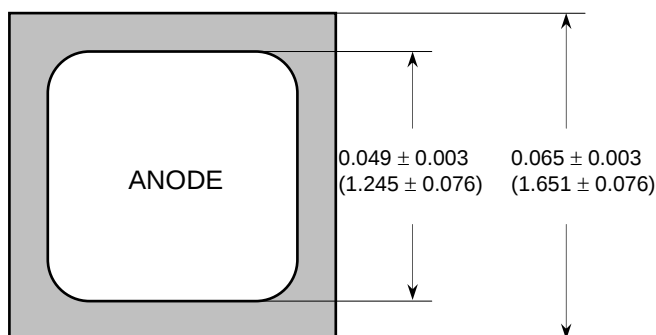


TECHNICAL DATA
DATA SHEET 2022, REV. -**ULTRA FAST RECOVERY
SILICON RECTIFIER DIE****Maximum Ratings:**

Characteristics	Symbol	Condition	Max.	Units
Peak Inverse Voltage	V_{RWM}	-	100	V
Max. Average Forward Current	$I_{F(AV)}$	@ 55°C	1.0	A
Die Size	-	-	65	mil
Max. Junction Temperature	T_J	-	-55 to +175	°C
Max. Storage Temperature	T_{stg}	-	-55 to +175	°C

Electrical Characteristics:

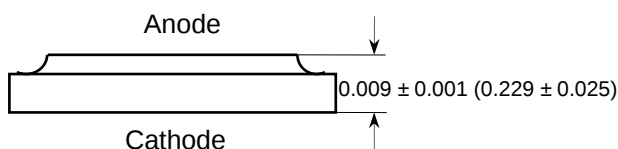
Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop	V_{F1}	@ 1.0A, Pulse, $T_J = 25^\circ\text{C}$	0.875	V
		Duty cycle $\leq 2\%$, pulse width $\leq 300\mu\text{s}$		
Max. Reverse Current	I_{R1}	@ $V_R = 100\text{V}$, Pulse, $T_J = 25^\circ\text{C}$	1.0	μA
	I_{R2}	@ $V_R = 100\text{V}$, Pulse, $T_J = 100^\circ\text{C}$	50	μA
Reverse Recovery Time	t_{rr}	$I_f = 500\text{mA}$, $I_r = 500\text{mA}$, $I_{rm} = 50\text{mA}$	25	ns

Mechanical Dimensions: In Inches (mm)

Bottom side metalization: Ti/Ni/Ag - 30 kÅ minimum.

Top side metalization: Al - 25 kÅ minimum

Bottom side is cathode, top side is anode.



TECHNICAL DATA
DATA SHEET 2022, REV. -

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